

HV9801A

Switch-Dimmable LED Driver

Features

- Four-level Switch Dimming
- Highly Accurate Current Regulator
- Output Overcurrent or Short-circuit Protection
- IC Overtemperature Protection

Applications

• Switch-dimmable LED Bulbs and Fixtures

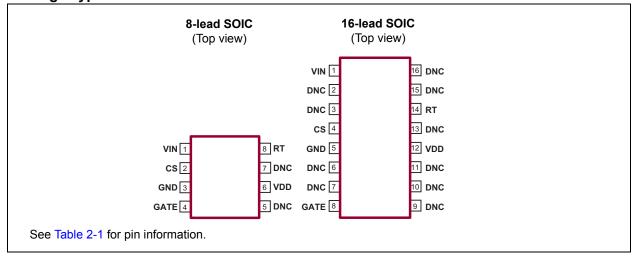
General Description

The HV9801A LED driver is ideally suited for switch-dimmable applications using LED bulbs and fixtures.

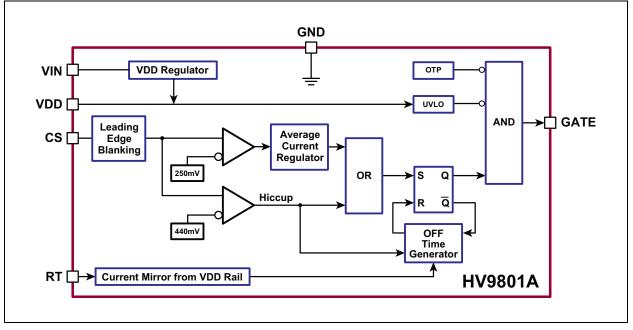
Through switch dimming, the lamp can be adjusted to four discrete brightness levels by rapid cycling of the light switch. The brightness levels are traversed in an up-and-down manner. Brightness resumes at the highest level when power is removed for more than a second.

The device can be powered directly from rectified AC through an internal V_{DD} regulator rated at 450V.

Package Types

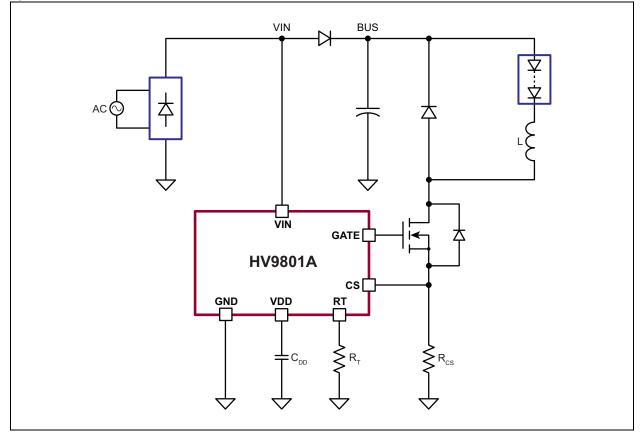


Functional Block Diagram



HV9801A

Typical Application Circuit



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings†

V _{IN}	
V _{DD}	
V _{CS} , V _{GATE}	
Junction Temperature Range, T ₁	
Storage Temperature Range, T _S	
Power Dissipation ($T_A = 25 \text{ °C}$):	
8-lead SOIC	650 mW
16-lead SOIC	1000 mW

† Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

Electrical Specifications : Specifications are at $T_A = 25^{\circ}C$, $V_{IN} = 15V$ unless otherwise noted.											
Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions					
INPUT					•						
Input Voltage	V _{IN}	15	—	450	V	Note 2					
Input Current	I _{IN}		1	2	mA						
Supply Current, OTP Shutdown	I _{IN, OT}		_	500	μA	Note 1					
V _{DD} REGULATOR											
Undervoltage Lockout Threshold	V _{UVLO}	6.45	6.7	7.1	V	V _{IN} rising (Note 2)					
Undervoltage Lockout Hysteresis	ΔV_{UVLO}		500	—	mV	V _{IN} falling					
Maximum Input Current, Limited by UVLO	1	3.5	_	—	mA	T _A = 25°C (Note 1)					
Maximum input current, Limited by OVEO	I _{UVLO}	1.5	_	—	mA	T _A = 125°C (Note 1)					
Output Voltage	V _{DD}	7.25	7.5	7.75	V	C_{GATE} = 500 pF, R_T = 226 k Ω					
Line Regulation	$\Delta V_{DD, LINE}$		_	1	V	V _{IN} = 15V to 450V, C _{GATE} = 500 pF, R _T = 226 kΩ					
V _{DD} Voltage Margin	$\Delta V_{DD(UV)}$	500	_	_	mV	$\Delta V_{DD(UV)} = V_{DD} - V_{UVLO, FALL}$ (Note 2)					
Load Regulation	$\Delta V_{DD, LOAD}$	_	_	100	mV	I_{VDD} = 0 mA to 1 mA, C _{GATE} = 500 pF, R _T = 226 kΩ					
SWITCH DIMMING											
Supply Current after Power Loss	I _{VDDX}	_		700	μA	Note 2					
Undervoltage Lockout during V _{IN} Power Loss	V _{UVLO, DIM}		3.5	_	V	V _{IN} falling					
Power Loss, Qualification Time	T _{PL1}	_	60	—	ms	V _{IN} falling below V _{UVLO}					
Power Loss, Time to Reset	T _{PL2}	_	1	—	s	(Note 1)					
PWM Dimming Frequency	F _{PWM}	_	1.2	—	kHz						
LED CURRENT REGULATOR			•	•							
Current Sense Threshold	V _{CST}	236	250	256	mV	Note 2					

Note 1: Determined by characterization; not production tested

2: Specifications apply over the full operating ambient temperature range of $-40^{\circ}C < T_A < +125^{\circ}C$.

ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical Specifications : Specifications are at $T_A = 25^{\circ}C$, $V_{IN} = 15V$ unless otherwise noted.											
Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions					
Leading Edge Blanking Time	T _{LEB}	110	—	260	ns	Note 2					
Minimum On-time	T _{ONX}	_		760	ns	V _{CS} = V _{CST} + 30 mV					
Maximum Duty Cycle Maintaining Regulation	D _{MAX}	80	_	_	%	LED current falls beyond this duty cycle					
SHORT-CIRCUIT PROTECTION		•	•	•	•						
Hiccup Threshold	V _{CSH}	_	440		mV						
V _{CS} High to Gate Low Delay	T _{DLY}	_		180	ns	V _{CS} = V _{CSH} + 30 mV					
Hiccup Time	T _{SCH}	_	750	—	μs						
Minimum On-time	T _{ONXSC}	_		430	ns	V _{CS} = V _{DD}					
T _{OFF} TIMER											
Off-time	т	32	40	48		R _T = 1 MΩ					
On-ume	T _{OFF}	8	10	12	μs	R _T = 226 kΩ					
GATE DRIVER											
Sourcing Current	I _{SRC}	165	—	—	mA	V _{GATE} = 0V					
Sinking Current	I _{SINK}	165	—	—	mA	V _{GATE} = V _{DD}					
Rise Time	t _r	—	30	50	ns	C _{GATE} = 500 pF					
Fall Time	t _f	—	30	50	ns	C _{GATE} = 500 pF					
OVERTEMPERATURE PROTECTION											
Trip Temperature	T _{TRIP}	—	140		°C	Note 1					
Hysteresis	ΔT_{TRIP}	_	20	—	°C	Note 1					

Note 1: Determined by characterization; not production tested

2: Specifications apply over the full operating ambient temperature range of -40° C < T_A < +125°C.

TEMPERATURE SPECIFICATIONS

Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions
TEMPERATURE RANGE						
Operating Ambient Temperature	T _A	-40	—	+125	°C	
Maximum Junction Temperature	Т _Ј	-40	_	+150	°C	
Storage Temperature	Τ _S	-65	_	+150	°C	
PACKAGE THERMAL RESISTANCE			•			
8-lead SOIC	θ_{JA}		101		°C/W	
16-lead SOIC	θ_{JA}		83	—	°C/W	

2.0 PIN DESCRIPTION

The details on the pins of HV9801A are listed on Table 2-1. See location of pins in **Package Types**.

Pin Name	8-lead SOIC Pin Number	16-lead SOIC Pin Number	Description
VIN	1	1	Connect to bridge rectifier output. Supplies power to the V_{DD} regulator. Detects light switch power-off event through loss of bridge rectifier output voltage. Do not connect excessive capacitance before or after the bridge to allow V_{IN} to drop rapidly after loss of power.
CS	2	4	Current sense input
GND	3	5	Ground
GATE	4	8	Gate driver output
VDD	6	12	V_{DD} regulator output. Connect a high-frequency bypass and a hold-up capacitor at V_{DD} . Bypass capacitor to be 100 nF minimum. See Section 3.0 "Application Information " for hold-up capacitance.
RT	8	14	Off-time programming input. Connect programming resistor to GND.
DNC	5, 7	2, 3, 6, 7, 9, 10, 11, 13, 15, 16	Stands for "Do Not Connect."

TABLE 2-1: PIN FUNCTION TABLE

3.0 APPLICATION INFORMATION

3.1 Current Control

3.1.1 CONTINUOUS CONDUCTION MODE (CCM)

The HV9801A is designed to control a buck converter operating in CCM.

Continuous Conduction Mode operation is characterized by converter operation with non-zero inductor current throughout the switching cycle. Such operation can be achieved by proper selection of the inductance.

3.1.2 LED CURRENT

The HV9801A regulates the LED current with an accuracy far superior to that of competing Peak Current mode controllers.

Average LED current is set by the current sense resistor R_{CS} and the current regulator reference voltage. See Equation 3-1 and Equation 3-2.

EQUATION 3-1:

 $V = I \times R$

EQUATION 3-2:

 $250mV = I_{LED} \times R_{CS}$

For example, a 2Ω resistor corresponds to a 125 mA (average) LED current.

3.1.3 CURRENT CONTROL PERFORMANCE

The control method of the HV9801A virtually eliminates the regulation errors associated with Peak Current mode controllers, such as errors caused by inductor tolerance, propagation delay of the current sense comparator, tolerance in the oscillator frequency or off-timer and changes in line and load voltage.

Figure 3-1 compares the load regulation of the HV9801A and that of a device with peak current control. The graph clearly shows the difference in load regulation between the HV9801A and the HV9910B, which is a peak current regulator.

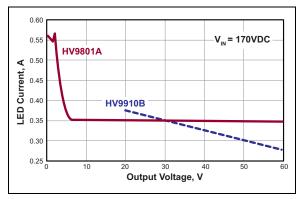


FIGURE 3-1: Output Characteristics of the HV9801A LED Driver.

3.2 Duty Cycle, Off-time, On-time and Inductor

3.2.1 DUTY CYCLE

The duty cycle (D) is related to the load voltage (V_{LED}) and input voltage (V_{BUS}) by the simple relation shown in Equation 3-3 and Equation 3-4.

EQUATION 3-3:

$$V_{OUT} = D \times V_{IN}$$

EQUATION 3-4:

$$V_{LED} = D \times V_{BUS}$$

3.2.2 OFF-TIME

The HV9801A operates with constant off-time control, which avoids subharmonic oscillation.

Switching period and switching frequency are related to on-time and off-time as shown in Equation 3-5 and Equation 3-6.

EQUATION 3-5:

$$T_{SW} = T_{ON} + T_{OFF}$$

EQUATION 3-6:

$$F_{SW} = \frac{1}{T_{SW}}$$

On-time is related to off-time and duty cycle. See Equation 3-7.

EQUATION 3-7:

$$D = \frac{T_{ON}}{(T_{ON} + T_{OFF})}$$
$$T_{ON} = [D/(1-D)] \times T_{OFF}$$

With a given T_{OFF}, the HV9801A dynamically adjusts T_{ON} to regulate the LED current. Specifically, T_{ON} adapts to the duty cycle associated with the given V_{BUS} and V_{LED}.

3.2.3 OFF-TIME PROGRAMMING

Off-time is programmed by the R_{T} resistor as illustrated in Equation 3-8.

EQUATION 3-8:

$$T_{OFF} = (A \times R_T) + B$$

Where: A = 40 ps / Ω and B = 300 ns

For instance, a 200 $k\Omega$ resistor corresponds to 8.3 μs off-time.

An acceptable range for R_T is 30 k Ω to 1 $M\Omega,$ corresponding to an off-time range between 1.5 μs and 40.3 $\mu s.$

3.2.4 INDUCTOR

Because the converter should operate in CCM, the inductor current should not fall to zero within a switching cycle and the inductor current ripple should be sized accordingly.

A common choice for peak-to-peak inductor current ripple (PPR) is 30% to 40% of nominal LED current.

Inductance can be calculated from the current drop during off-time as shown in Equation 3-9 and Equation 3-10.

EQUATION 3-9:

$$L \times \Delta I = V \times \Delta T$$

EQUATION 3-10:

$$L \times PPR \times I_{LED} = V_{LED} \times T_{OFF}$$

For example, 30% PPR on 350 mA average current equates to 105 mA ripple, which together with 5 μs off-time and 30V LED string voltage corresponds to 1.43 mH inductance.

A design with 30V LED voltage and 150V bus voltage corresponds to a 20% duty cycle, while a 120V bus voltage coincides with a 25% duty cycle. A 20% duty cycle corresponds to 1.25 µs on-time, and a 25% duty

cycle corresponds to 1.67 μs on-time. Hence, the switching frequency is 160 kHz at 150V bus voltage and 150 kHz at 120V bus voltage.

3.2.5 MAXIMUM DUTY CYCLE

Duty cycle should be limited to the specified maximum of 80%. Accordingly, the targeted LED string voltage and the bus voltage are limited to the same ratio. Operation at a larger desired duty cycle than the maximum duty cycle results in an LED current lower than programmed.

3.2.6 MINIMUM DUTY CYCLE

Duty cycle is limited on the low side by the minimum on-time specification (760 ns). Operation at a smaller desired on-time than the minimum causes the LED current to exceed the programmed value.

LED string voltage cannot be made arbitrarily low. Minimum LED string voltage can be determined with Equation 3-11.

EQUATION 3-11:

$$D_{MIN} = \frac{T_{ONX}}{(T_{OFF} + T_{ONX})}$$
$$V_{LED} = D_{MIN} \times V_{BUS}$$

For instance, with 5 μ s off-time, the duty cycle should be kept above 13%. Such a duty cycle corresponds to an LED string voltage of 19.5V at 150V bus voltage.

A design that needs a lower LED string voltage requires a longer off-time.

3.2.7 SHORT-CIRCUIT PROTECTION

An increase in the LED current sense signal above 440 mV (176% of nominal) trips the short-circuit comparator, thereby causing the converter to switch to Hiccup mode. In Hiccup mode, off-time is lengthened to about 750 μ s to allow the inductor current to drop to a safe level.

Without the extended off-time, the inductor current increases with every switching cycle, causing an overcurrent damage to the converter.

The off-time extension can be observed in Figure 3-2 below.

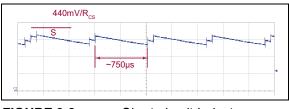


FIGURE 3-2: Current.

Short-circuit Inductor

3.2.8 LEADING EDGE BLANKING

The MOSFET drain current and the current sense signal exhibit a spike at the start of a switching cycle, which arises from the MOSFET gate charging current and the current required for discharging the MOSFET drain node. These two currents typically exceed the inductor by quite a margin.

The current sense signal is blanked at the start of the switching cycle in order to avoid a premature trigger of the current sense and the short-circuit protection comparators.

3.2.9 V_{DD} REGULATOR

The V_{DD} regulator generates a source of regulated voltage for operation of internal and external circuits from the power applied at the V_{IN} pin. Alternatively, the V_{DD} voltage can be supplied from a source directly connected to the V_{DD} pin.

3.3 Switch Dimming

3.3.1 GENERAL

Lamp brightness can be adjusted to one of four discrete levels by rapidly cycling power with the light switch. The brightness levels are traversed in an up-and-down manner, the four levels being 100%, 50%, 25% and 12.5%. Brightness resumes at the highest level when power is removed for more than a second.

Reduction of LED current is accomplished through PWM dimming with a PWM dimming frequency of about 1 kHz. The PWM frequency is generated by an internal oscillator, and the PWM duty cycle is controlled by digital logic.

Turning the light switch off and on within one second adjusts LED current to the next level in each dimming step. The direction of dimming depends on the existing position in the dimming sequence. The illustration in Figure 3-3 shows more details. The sequence starts at 100% and adjusts to the next lower level by the first dimming step and then adjusts to the next lower level by the next dimming step. Upon reaching the lowest or highest level, the direction of the sequence reverses. Therefore, the actual overall dimming sequence is 100%, 50%, 25%, 12.5%, 25%, 50%, 100%, and the sequence repeats as the dimming steps continue. When power is removed for more than one second, the dimming sequence is terminated and the brightness is reset to 100% upon turn-on of the light switch.

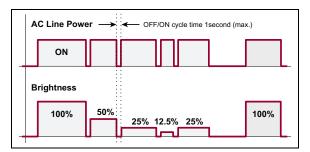


FIGURE 3-3: LED Brightness and AC Line Power.

3.3.2 V_{DD} CAPACITOR

The V_{DD} voltage should be maintained for at least one second and above the 3.5V level after loss of V_{IN} power to allow certain timing circuits to function.

The minimum V_{DD} capacitance required can be calculated with Equation 3-12.

EQUATION 3-12:

$$C \times \Delta V = I \times \Delta T$$
$$C_{DD} \times (7.5V - 3.5V) = I_{VDDX} \times 1s$$

With 700 μA of I_{VDDX} the bypass capacitance should be 175 $\mu F.$

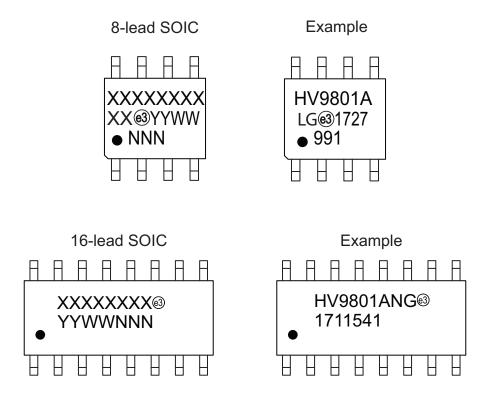
3.3.3 DETECTION OF POWER CYCLING

The presence of AC line power is detected at the $V_{\rm IN}$ pin. To this end, loss of AC power should result in a rapidly falling voltage at the output of the bridge rectifier.

The V_{IN} voltage drops due to the current draw from the V_{DD} regulator. In order to facilitate a quick drop in voltage, a diode should be added to isolate the bus capacitor from the V_{IN} pin as shown in the **Typical Application Circuit**.

4.0 PACKAGING INFORMATION

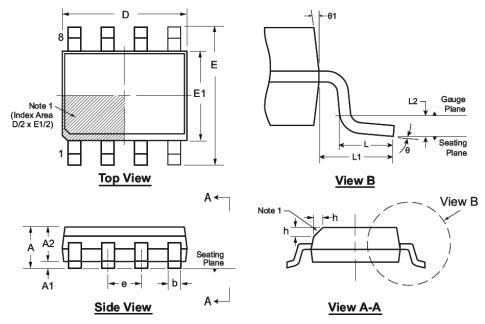
4.1 Package Marking Information



Lege	nd: XXX Y YY WW NNN @3 *	Product Code or Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC [®] designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.
Note:	be carrie characters	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available s for product code or customer-specific information. Package may or e the corporate logo.

8-Lead SOIC (Narrow Body) Package Outline (LG/TG)

4.90x3.90mm body, 1.75mm height (max), 1.27mm pitch



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

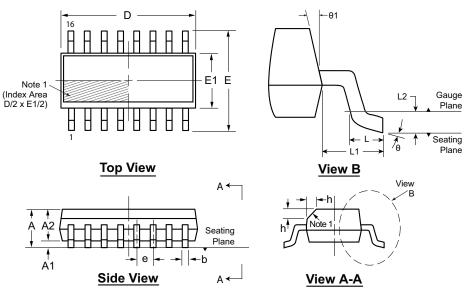
Note:

This chamfer feature is optional. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator. 1.

Symbo	I	A	A1	A2	b	D	E	E1	e	h	L	L1	L2	θ	θ1
	MIN	1.35*	0.10	1.25	0.31	4.80*	5.80*	3.80*				0 0	5 ⁰		
Dimension (mm)	NOM	-	-	-	-	4.90	6.00	3.90	1.27 BSC	-	-	1.04 REF	0.25 BSC	-	-
()	MAX	1.75	0.25	1.65*	0.51	5.00*	6.20*	4.00*		0.50	1.27			8 0	15 ⁰

JEDEC Registration MS-012, Variation AA, Issue E, Sept. 2005. * This dimension is not specified in the JEDEC drawing. Drawings are not to scale.

16-Lead SOIC (Narrow Body) Package Outline (NG) 9.90x3.90mm body, 1.75mm height (max), 1.27mm pitch



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

Note:

1. This chamfer feature is optional. If it is not present, then a Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbo	ol	Α	A1	A2	b	D	Е	E1	е	h	L	L1	L2	θ	θ1
	MIN	1.35*	0.10	1.25	0.31	9.80*	5.80*	3.80*		0.25	0.40			0 0	5°
Dimension (mm)	NOM	-	-	-	-	9.90	6.00	3.90	1.27 BSC	-	-	1.04 REF	0.25 BSC	-	-
()	MAX	1.75	0.25	1.65*	0.51	10.00*	6.20*	4.00*	200	0.50	1.27		200	8 0	15°

JEDEC Registration MS-012, Variation AC, Issue E, Sept. 2005. * This dimension is not specified in the JEDEC drawing.

Drawings are not to scale.

APPENDIX A: REVISION HISTORY

Revision A (September 2017)

- Converted Supertex Doc# DSFP-HV9801A to Microchip DS20005692A
- Updated the part marking format
- Removed the 16-lead SOIC Narrow (NG) M934
 media type
- Changed the quantity of the 8-lead SOIC (Narrow) LG package from 2500/Reel to 3300/Reel
- Made minor text changes throughout the document

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART NO.	<u>xx</u>		· ¥ - ¥	Ex	amples:	
Device	Package Options		Environmental Media Type	a)	HV9801ALG-G:	Switch-Dimmable LED Driver, 8-lead SOIC Package, 3300/Reel
Device:	HV9801A	=	Switch-Dimmable LED Driver	b)	HV9801ANG-G:	Switch-Dimmable LED Driver, 16-lead SOIC Package, 45/Tube
Packages:	LG	=	8-lead SOIC			
	NG	=	16-lead SOIC			
Environmental:	G	=	Lead (Pb)-free/RoHS-compliant Package			
Media Type:	(blank)	=	3300/Reel for an LG Package			
		=	45/Tube for an NG Package			

Note the following details of the code protection feature on Microchip devices:

- · Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC[®] MCUs and dsPIC[®] DSCs, KEELOQ[®] code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.

QUALITY MANAGEMENT SYSTEM CERTIFIED BY DNV = ISO/TS 16949=

Trademarks

The Microchip name and logo, the Microchip logo, AnyRate, AVR, AVR logo, AVR Freaks, BeaconThings, BitCloud, CryptoMemory, CryptoRF, dsPIC, FlashFlex, flexPWR, Heldo, JukeBlox, KEELoa, KEELoa logo, Kleer, LANCheck, LINK MD, maXStylus, maXTouch, MediaLB, megaAVR, MOST, MOST logo, MPLAB, OptoLyzer, PIC, picoPower, PICSTART, PIC32 logo, Prochip Designer, QTouch, RightTouch, SAM-BA, SpyNIC, SST, SST Logo, SuperFlash, tinyAVR, UNI/O, and XMEGA are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

ClockWorks, The Embedded Control Solutions Company, EtherSynch, Hyper Speed Control, HyperLight Load, IntelliMOS, mTouch, Precision Edge, and Quiet-Wire are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Adjacent Key Suppression, AKS, Analog-for-the-Digital Age, Any Capacitor, AnyIn, AnyOut, BodyCom, chipKIT, chipKIT logo, CodeGuard, CryptoAuthentication, CryptoCompanion, CryptoController, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, EtherGREEN, In-Circuit Serial Programming, ICSP, Inter-Chip Connectivity, JitterBlocker, KleerNet, KleerNet logo, Mindi, MiWi, motorBench, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICkit, PICtail, PureSilicon, QMatrix, RightTouch logo, REAL ICE, Ripple Blocker, SAM-ICE, Serial Quad I/O, SMART-I.S., SQI, SuperSwitcher, SuperSwitcher II, Total Endurance, TSHARC, USBCheck, VariSense, ViewSpan, WiperLock, Wireless DNA, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

Silicon Storage Technology is a registered trademark of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2017, Microchip Technology Incorporated, All Rights Reserved. ISBN: 978-1-5224-2134-4



Worldwide Sales and Service

AMERICAS

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: http://www.microchip.com/ support

Web Address: www.microchip.com

Atlanta Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Austin, TX Tel: 512-257-3370

Boston Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL Tel: 630-285-0071 Fax: 630-285-0075

Dallas Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit Novi, MI Tel: 248-848-4000

Houston, TX Tel: 281-894-5983

Indianapolis Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453 Tel: 317-536-2380

Los Angeles Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608 Tel: 951-273-7800

Raleigh, NC Tel: 919-844-7510

New York, NY Tel: 631-435-6000

San Jose, CA Tel: 408-735-9110 Tel: 408-436-4270

Canada - Toronto Tel: 905-695-1980 Fax: 905-695-2078

ASIA/PACIFIC

Asia Pacific Office Suites 3707-14, 37th Floor Tower 6, The Gateway Harbour City, Kowloon

Hong Kong Tel: 852-2943-5100 Fax: 852-2401-3431

Australia - Sydney Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

China - Beijing Tel: 86-10-8569-7000 Fax: 86-10-8528-2104

China - Chengdu Tel: 86-28-8665-5511 Fax: 86-28-8665-7889

China - Chongqing Tel: 86-23-8980-9588 Fax: 86-23-8980-9500

China - Dongguan Tel: 86-769-8702-9880

China - Guangzhou Tel: 86-20-8755-8029

China - Hangzhou Tel: 86-571-8792-8115 Fax: 86-571-8792-8116

China - Hong Kong SAR Tel: 852-2943-5100

China - Nanjing Tel: 86-25-8473-2460 Fax: 86-25-8473-2470

Fax: 852-2401-3431

China - Qingdao Tel: 86-532-8502-7355 Fax: 86-532-8502-7205

China - Shanghai Tel: 86-21-3326-8000 Fax: 86-21-3326-8021

China - Shenyang Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

China - Shenzhen Tel: 86-755-8864-2200 Fax: 86-755-8203-1760

China - Wuhan Tel: 86-27-5980-5300 Fax: 86-27-5980-5118

China - Xian Tel: 86-29-8833-7252 Fax: 86-29-8833-7256 ASIA/PACIFIC

China - Xiamen Tel: 86-592-2388138 Fax: 86-592-2388130

China - Zhuhai Tel: 86-756-3210040 Fax: 86-756-3210049

India - Bangalore Tel: 91-80-3090-4444 Fax: 91-80-3090-4123

India - New Delhi Tel: 91-11-4160-8631 Fax: 91-11-4160-8632

India - Pune Tel: 91-20-3019-1500

Japan - Osaka Tel: 81-6-6152-7160 Fax: 81-6-6152-9310

Japan - Tokyo Tel: 81-3-6880- 3770 Fax: 81-3-6880-3771

Korea - Daegu Tel: 82-53-744-4301 Fax: 82-53-744-4302

Korea - Seoul Tel: 82-2-554-7200 Fax: 82-2-558-5932 or 82-2-558-5934

Malaysia - Kuala Lumpur Tel: 60-3-6201-9857 Fax: 60-3-6201-9859

Malaysia - Penang Tel: 60-4-227-8870 Fax: 60-4-227-4068

Philippines - Manila Tel: 63-2-634-9065 Fax: 63-2-634-9069

Singapore Tel: 65-6334-8870 Fax: 65-6334-8850

Taiwan - Hsin Chu Tel: 886-3-5778-366 Fax: 886-3-5770-955

Taiwan - Kaohsiung Tel: 886-7-213-7830

Taiwan - Taipei Tel: 886-2-2508-8600 Fax: 886-2-2508-0102

Thailand - Bangkok Tel: 66-2-694-1351 Fax: 66-2-694-1350

EUROPE

Austria - Wels Tel: 43-7242-2244-39 Fax: 43-7242-2244-393

Denmark - Copenhagen Tel: 45-4450-2828 Fax: 45-4485-2829

Finland - Espoo Tel: 358-9-4520-820

France - Paris Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

France - Saint Cloud Tel: 33-1-30-60-70-00

Germany - Garching Tel: 49-8931-9700 **Germany - Haan** Tel: 49-2129-3766400

Germany - Heilbronn Tel: 49-7131-67-3636

Germany - Karlsruhe Tel: 49-721-625370

Germany - Munich Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Germany - Rosenheim Tel: 49-8031-354-560

Israel - Ra'anana Tel: 972-9-744-7705

Italy - Milan Tel: 39-0331-742611 Fax: 39-0331-466781

Italy - Padova Tel: 39-049-7625286

Netherlands - Drunen Tel: 31-416-690399 Fax: 31-416-690340

Norway - Trondheim Tel: 47-7289-7561

Poland - Warsaw Tel: 48-22-3325737

Romania - Bucharest Tel: 40-21-407-87-50

Spain - Madrid Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

Sweden - Gothenberg Tel: 46-31-704-60-40

Sweden - Stockholm Tel: 46-8-5090-4654

UK - Wokingham Tel: 44-118-921-5800 Fax: 44-118-921-5820

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for LED Lighting Drivers category:

Click to view products by Supertex manufacturer:

Other Similar products are found below :

LV5235V-MPB-H MB39C602PNF-G-JNEFE1 MIC2871YMK-T5 AL1676-10BS7-13 AL1676-20AS7-13 AP5726WUG-7 MX877RTR ICL8201 IS31BL3228B-UTLS2-TR IS31BL3506B-TTLS2-TR AL3157F-7 AP5725FDCG-7 AP5726FDCG-7 LV52204MTTBG AP5725WUG-7 STP4CMPQTR NCL30086BDR2G CAT4004BHU2-GT3 LV52207AXA-VH AP1694AS-13 TLE4242EJ AS3688 IS31LT3172-GRLS4-TR TLD2311EL KTD2694EDQ-TR KTZ8864EJAA-TR IS32LT3174-GRLA3-TR ZXLD1374QESTTC MP2488DN-LF-Z NLM0010XTSA1 AL1676-20BS7-13 MPQ7220GF-AEC1-P MPQ4425BGJ-AEC1-P MPQ7220GF-AEC1-Z MPQ4425BGJ-AEC1-Z IS31FL3737B-QFLS4-TR IS31FL3239-QFLS4-TR KTD2058EUAC-TR KTD2037EWE-TR DI05662ST6 IS31BL3508A-TTLS2-TR MAX20052CATC/V+ MAX25606AUP/V+ BD6586MUV-E2 BD9206EFV-E2 BD9416FS-E2 LYT4227E LYT6079C-TL MP3394SGF-P MP4689AGN-P